

Vishay Siliconix

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)		
- 20	0.019 at V _{GS} = - 4.5 V	- 11.4		
	0.025 at V _{GS} = - 2.5 V	- 9.9		
	0.034 at V _{GS} = - 1.8 V	- 8.5		

PowerPAK 1212-8

Bottom View

Si7411DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

Ordering Information: Si7411DN-T1-E3 (Lead (Pb)-free)

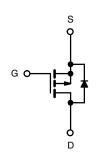
3.30 mm

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET: 1.8 V Rated
- New PowerPAK[®] Package
 - Low Thermal Resistance, RthJC
 - Low 1.07 mm Profile

APPLICATIONS

Load Switch



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 20		V	
Gate-Source Voltage		V _{GS}	± 8			
	T _A = 25 °C	– I _D	- 11.4	- 7.5		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 8.2	- 5.4		
Pulsed Drain Current		I _{DM}	- 30		A	
Continuous Source Current (Diode Conduction) ^a		۱ _S	- 3	- 1.3		
	T _A = 25 °C	P _D	3.6	1.5	W	
Maximum Power Dissipation ^a	T _A = 85 °C		1.9	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}			260		-U	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	t ≤ 10 s	R _{thJA}	28	35	
Maximum Junction-to-Ambient ^a	Steady State		65	81	°C/W
Maximum Junction-to-Case	Steady State		2.9	3.8	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



HALOGEN

FREE

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Parameter	Symbol	Test Conditions Min.		Тур.	Max.	Unit	
Static	•			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -300 \ \mu A$		- 1.0	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 V, V_{GS} = 0 V$			- 1	A	
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS}{\leq}$ - 5 V, V_{GS} = - 4.5 V	- 30			А	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 11.4 A		0.015	0.019	Ω	
		V _{GS} = - 2.5 V, I _D = - 9.9 A		0.020	0.025		
		$V_{GS} = -1.8 \text{ V}, \text{ I}_{D} = -2.9 \text{ A}$ 0.027					
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 11.4 A		35		S	
Diode Forward Voltage ^a	V _{SD}	I _S = - 3.0 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Qg			27	41		
Gate-Source Charge	Q _{gs}	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_D = - 11.4 A		3.9		nC	
Gate-Drain Charge	Q _{gd}			7			
Gate Resistance	Rg	f = 1 MHz		5		Ω	
Turn-On Delay Time	t _{d(on)}			23	35		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		45	70		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 1 A, V_GEN = - 4.5 V, R_g = 6 Ω		135	200	ns	
Fall Time	t _f			70	105]	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 3.2 A, dl/dt = 100 A/μs		29	50		

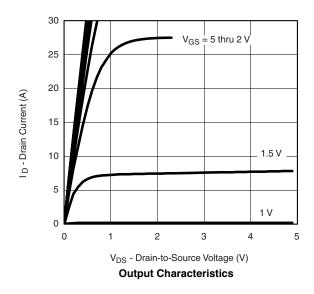
Notes:

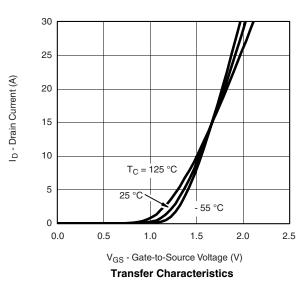
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

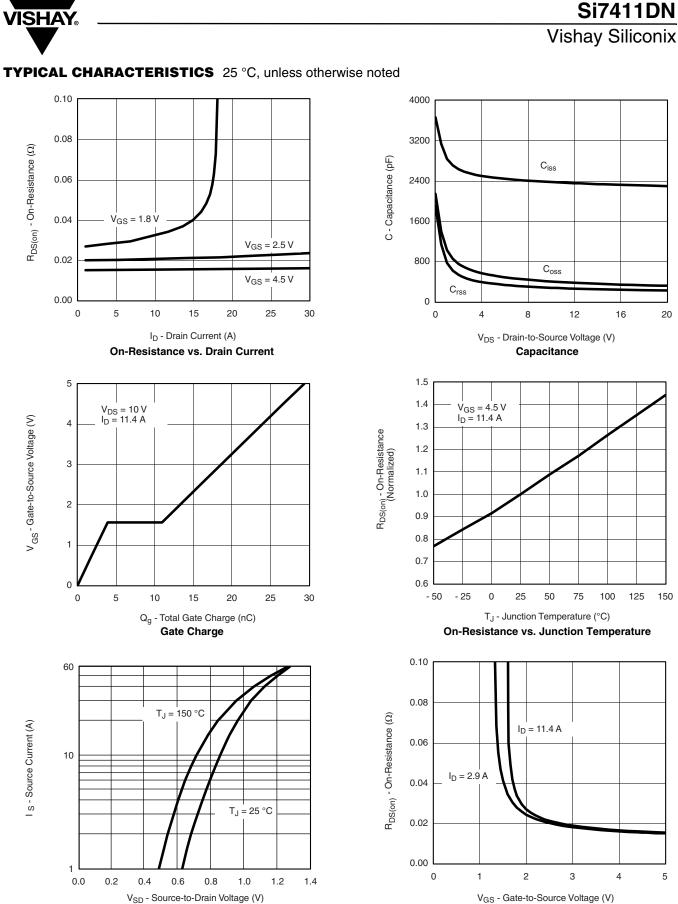
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







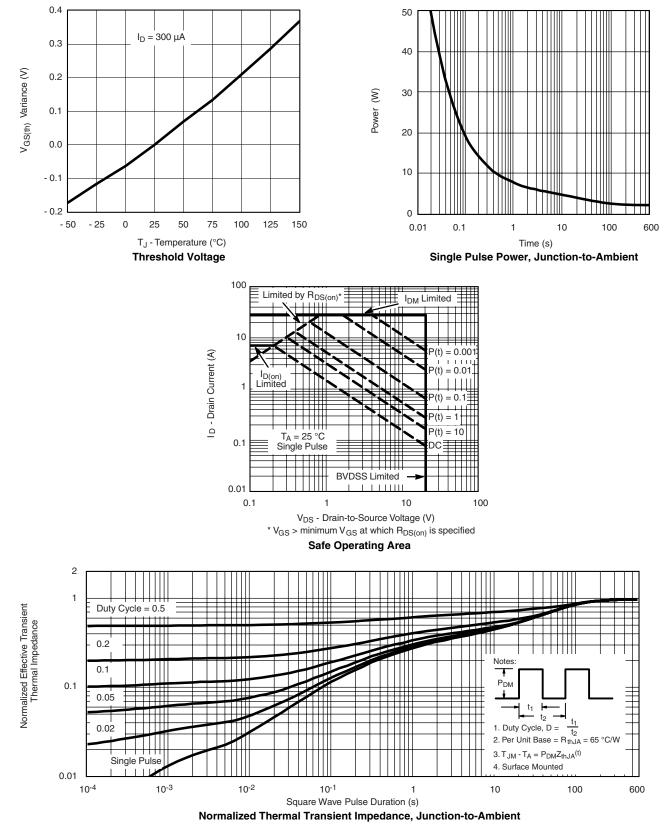
Source-Drain Diode Forward Voltage

Document Number: 72399 S-83051-Rev. E, 29-Dec-08 On-Resistance vs. Gate-to-Source Voltage

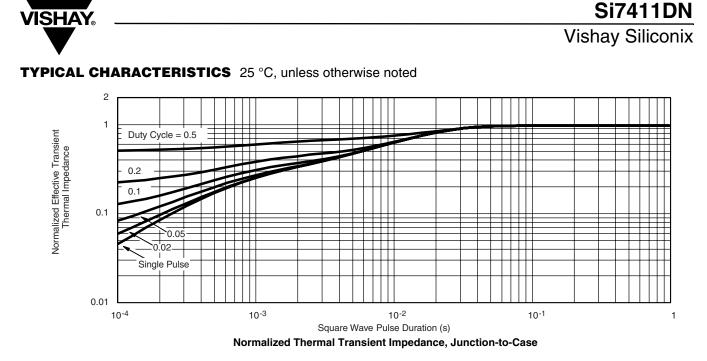
Si7411DN

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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?72399</u>.



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